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CLAIMS

- 1 A photocurable resin composition comprising:
 - (A) a component comprising a carboxyl group that may dissociate in the presence of an acid,
 - (B) a cationically polymerizable compound, and
 - (C) a cationic photoinitiator.
- The photocurable resin composition according to claim 1, wherein the component (A) comprises a compound (a1) having a structure of the following formula (1),

$$\begin{array}{ccc}
R^{1} - C - O - C - & & (1) \\
R^{1} - C - O - C - & & (1)
\end{array}$$

wherein R¹ represents an organic group having a polymerizable carbon-carbon double bond, and R² and R³ individually represent an alkyl group having 1-10 carbon atoms or an aryl group having 6-14 carbon atoms.

The photocurable resin composition according to claim 1 or 2, wherein the component (A) comprises a compound (a2) having the structure

wherein R¹² and R¹³ individually represent an alkyl group having 1-10 carbon atoms or an aryl group having 6–14 carbon atoms, R¹⁴ is an organic group with a valence of i, the R¹⁴ group indicating a single bond when i is 2, and i is

an integer of 2-4, provided that one of R¹², R¹³, and R¹⁴ is an alkyl group having 1-10 carbon atoms.

The photocurable resin composition according to anyone of claims 1-3, wherein the component (A) comprises a compound (a3) having the structure

$$\left(HO - \frac{R^{15}}{C}\right)_{j} \qquad (5)$$

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wherein R^{15} represents an alkyl group having 1-10 carbon atoms, R^{16} represents an alkyl group having 1-10 carbon atoms or an aryl group having 6–14 carbon atoms, R^{17} individually represents an alkyl group having 1-5 carbon atoms, j is an integer of 2-4, and m is an integer of 0-4, provided j + m \leq 6.

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The photocurable resin composition according to anyone of claims 1-4, wherein the component (A) comprises a compound (a4) having the structure

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wherein R¹⁸ represents an alkyl group having 1-10 carbon atoms, R¹⁹ represents an alkyl group having 1-10 carbon atoms or an aryl group having 6–14 carbon atoms, R²⁰ individually represents an alkyl group having 1-5 carbon atoms, R²¹ is an organic group having a valence of z, -O-, -S-, -CO-, or SO₂, k is an integer of 1 or 2, n is an integer of 0-3, and z is an integer of 2-4.

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6 The photocurable resin composition according to anyone of claims 1-5,

wherein the component (A) comprises 2,5-dimethylhexane-2,5-di(meth)acrylate or 1,3-di(2-hydroxypropyl)benzene-di(meth)acrylate.

The photocurable resin composition according to anyone of claims 1-6, wherein the component (A) comprises a compound (b1) having the structure

$$R^{4}$$
-C-O-C- R^{5} (2)

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wherein, R⁴ represents an organic group having a polymerizable carbon-carbon double bond, R⁵ represents an alkyl group having 1-10 carbon atoms, and R⁶ and R⁷ represent an alkyl group having 1-10 carbon atoms, monovalent alicyclic group having 6-20 carbon atoms, or monovalent aryl group having 6-20 carbon atoms.

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The photocurable resin composition according to anyone of claims 1-7, wherein the component (A) comprises a compound (b2) having the structure

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wherein R⁸ represents an organic group having a polymerizable carbon-carbon double bond, R⁹ represents a hydrogen atom, alkyl group having 1-10 carbon atoms, alicyclic group having 3-10 carbon atoms, aryl group having 6-10 carbon atoms, or aralkyl group having 7-11 carbon atoms, R¹⁰ and R¹¹ individually represent an alkyl group having 1-10 carbon atoms, haloalkyl group having 1-10 carbon atoms, alicyclic group having 3-10 carbon atoms, aryl group having 6-10 carbon atoms, or aralkyl group having 7-11 carbon atoms, or any two of R⁹, R¹⁰, and R¹¹ may bond to form a 5-7 member ring.

	9	The photocurable resin composition according to anyone of claims 1-8,
		wherein the component (A) comprises a compound (c), which is a (co)polymer
		prepared from monomers comprising the compounds (a) and/or (b).
	10	The photocurable resin composition according to claim 9, wherein the
5	•	(co)polymer is prepared from monomers comprising 10-100 mol% of
		component (b).
	11	The photocurable resin composition according to claim 9-10, wherein the
		polystyrene-reduced weight average molecular weight of the copolymer (c)
		determined by gel permeation chromatography (GPC) is 1,000-500,000
10	12	The photocurable resin composition according to anyone of claims 1-11,
		wherein the proportion of the component (A) used in the photocurable resin
		composition of the present invention is 1-50 wt%.
	13	The photocurable resin composition according to anyone of claims 1-12,
		wherein the component (B) contains 50 wt% or more of epoxy compounds.
15	14	The photocurable resin composition according to anyone of claims 1-13,
		wherein the component (B) is present in an amount from 20-90 wt%.
	15	The liquid photocurable resin composition according to anyone of claims 1-14,
		further comprising (D) elastomer particle having a number average particle
		diameter of 10 to 1,000 nm.
20	16	The liquid photocurable resin composition according to anyone of claims 1-15,
		further comprising (E) an ethylenically unsaturated monomer other than the
		component (A), and (F) a radical photoinitiator.
	17	The liquid photocurable resin composition according to anyone of claims 1-16,
		further comprising (G) a polyether polyol compound having one or more
25		hydroxyl groups in the molecule.

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A photofabricated product obtained by curing the liquid photocurable resin

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composition according to any one of claims 1-17 by applying light.

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